74AHC594-Q100; 74AHCT594-Q100

8-bit shift register with output register

Rev. 4 — 7 July 2021

Product data sheet

1. General description

The 74AHC594-Q100; 74AHCT594-Q100 is a high-speed Si-gate CMOS device and is pin compatible with Low-Power Schottky TTL (LSTTL). It is specified in compliance with JEDEC standard No. 7-A.

The 74AHC594-Q100; 74AHCT594-Q100 is an 8-bit, non-inverting, serial-in, parallel-out shift register that feeds an 8-bit D-type storage register. Separate clocks (SHCP and STCP) and direct overriding clears (SHR and STR) are provided on both the shift and storage registers. A serial output (Q7S) is provided for cascading purposes.

Both the shift and storage register clocks are positive-edge triggered. If the user wishes to connect both clocks together, the shift register will always be one count pulse ahead of the storage register.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 2.0 V to 5.5 V
- Balanced propagation delays
- · All inputs have Schmitt-trigger action
- Overvoltage tolerant inputs to 5.5 V
- · High noise immunity
- CMOS low power dissipation
- 8-bit serial-in, parallel-out shift register with storage
- Independent direct overriding clears on shift and storage registers
- · Independent clocks for shift and storage registers
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level A
- Input levels:
 - For 74AHC594-Q100: CMOS level
 - For 74AHCT594-Q100: TTL level
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pf, R = 0 Ω)
- Multiple package options
- DHVQFN package with Side-Wettable Flanks enabling Automatic Optical Inspection (AOI) of solder joints

3. Applications

- · Serial-to parallel data conversion
- · Remote control holding register

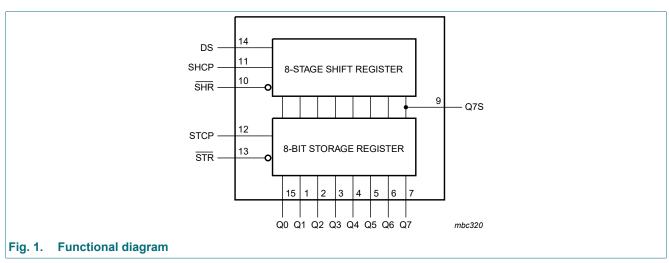


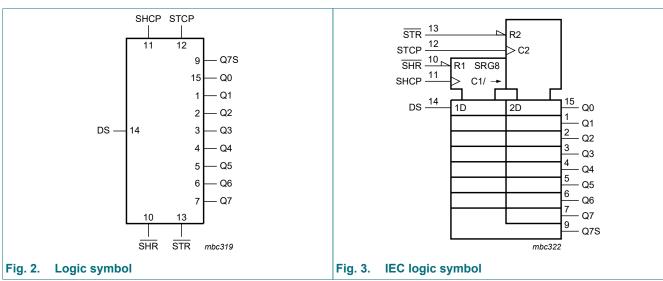
4. Ordering information

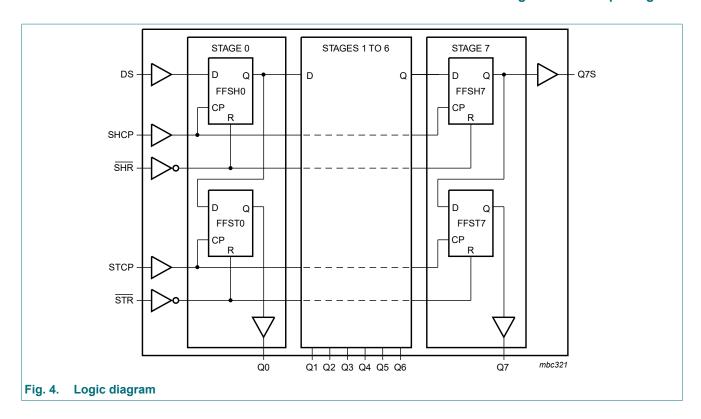
Table 1. Ordering information

Type number	Package					
	Temperature Name Description range					
74AHC594D-Q100	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads;	SOT109-1		
74AHCT594D-Q100	-		body width 3.9 mm			
74AHC594PW-Q100	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads;	SOT403-1		
74AHCT594PW-Q100	-		body width 4.4 mm			
74AHC594BQ-Q100	-40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal	SOT763-1		
74AHCT594BQ-Q100	1		enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 × 3.5 × 0.85 mm			

5. Functional diagram

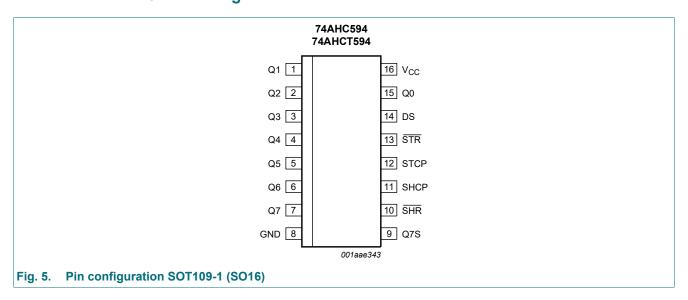


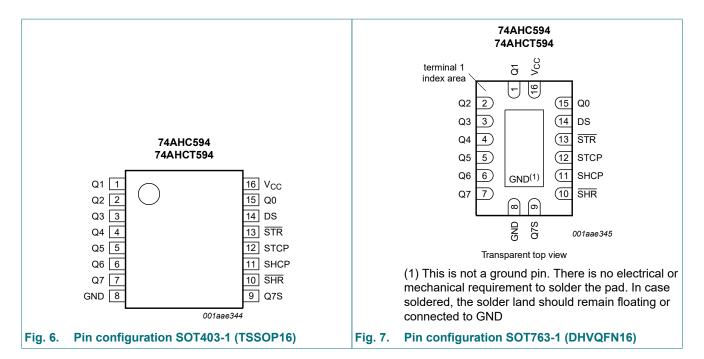




6. Pinning information

6.1. Pinning





6.2. Pin description

Table 2. Pin description

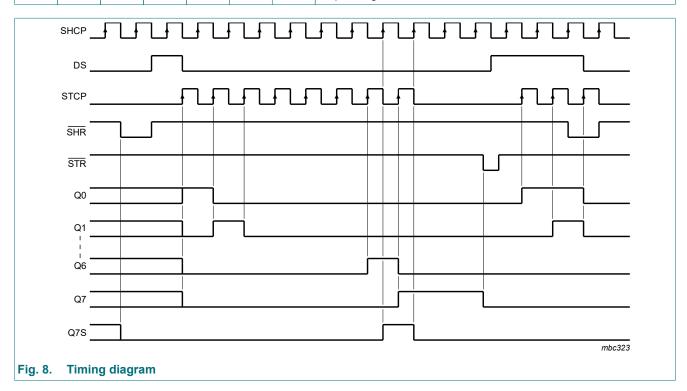
Symbol	Pin	Description
Q0, Q1, Q2, Q3, Q4, Q5, Q6, Q7	15, 1, 2, 3, 4, 5, 6, 7	parallel data output
GND	8	ground (0 V)
Q7S	9	serial data output
SHR	10	shift register reset input (active LOW)
SHCP	11	shift register clock input
STCP	12	storage register clock input
STR	13	storage register reset input (active LOW)
DS	14	serial data input
V _{CC}	16	supply voltage

7. Functional description

Table 3. Function table

 $H = HIGH \ voltage \ state; \ L = LOW \ voltage \ state; \ \uparrow = LOW \ to \ HIGH \ transition; \ X = don't \ care; \ NC = no \ change.$

Input					Outpu	t	Function
SHCP	STCP	SHR	STR	DS	Q7S	Qn	-
X	Х	L	Х	X	L	NC	a LOW-state on SHR only affects the shift register
X	Х	Х	L	X	NC	L	a LOW-state on STR only affects the storage register
Χ	1	L	Н	X	L	L	empty shift register loaded into storage register
1	Х	Н	Х	Н	Q6S	NC	logic HIGH level shifted into shift register stage 0. Contents of all shift register stages shifted through, e.g. previous state of stage 6 (internal Q6S) appears on the serial output (Q7S).
Х	1	Н	Н	Х	NC	QnS	contents of shift register stages (internal QnS) are transferred to the storage register and parallel output stages
1	1	Н	Н	Х	Q6S	QnS	contents of shift register shifted through; previous contents of the shift register is transferred to the storage register and the parallel output stages



8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7.0	V
VI	input voltage			-0.5	+7.0	V
I _{IK}	input clamping current	V _I < -0.5 V	[1]	-20	-	mA
I _{OK}	output clamping current	V_{O} < -0.5 V or V_{O} > V_{CC} + 0.5 V	[1]	-20	+20	mA
Io	output current	$V_{O} = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$		-25	+25	mA
I _{CC}	supply current			-	+75	mA
I _{GND}	ground current			-75	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	T _{amb} = -40 °C to +125 °C	[2]	-	500	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

9. Recommended operating conditions

Table 5. Operating conditions

Symbol	Parameter	Conditions	74A	74AHC594-Q100		74Al	ICT594-	Q100	Unit
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	5.5	4.5	5.0	5.5	V
VI	input voltage		0	-	5.5	0	-	5.5	V
Vo	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 3.0 V to 3.6 V	-	-	100	-	-	-	ns/V
		V _{CC} = 4.5 V to 5.5 V	-	-	20	-	-	20	ns/V

^[2] For SOT109-1 (SO16) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C. For SOT403-1 (TSSOP16) package: P_{tot} derates linearly with 8.5 mW/K above 91 °C. For SOT763-1 (DHVQFN16) package: P_{tot} derates linearly with 11.2 mW/K above 106 °C.

10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74AHC5	94-Q100									
V_{IH}	HIGH-level	V _{CC} = 2.0 V	1.5	-	-	1.5	-	1.5	-	V
	input voltage	V _{CC} = 3.0 V	2.1	-	-	2.1	-	2.1	-	V
		V _{CC} = 5.5 V	3.85	-	-	3.85	-	3.85	-	V
V_{IL}	LOW-level	V _{CC} = 2.0 V	-	-	0.5	-	0.5	-	0.5	V
	input voltage	V _{CC} = 3.0 V	-	-	0.9	-	0.9	-	0.9	V
		V _{CC} = 5.5 V	-	-	1.65	-	1.65	-	1.65	V
V _{OH}	HIGH-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = -50 μA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		$I_O = -50 \mu A; V_{CC} = 3.0 V$	2.9	3.0	-	2.9	-	2.9	-	V
		I _O = -50 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		$I_O = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.58	-	-	2.48	-	2.40	-	V
		I_{O} = -8.0 mA; V_{CC} = 4.5 V	3.94	-	-	3.80	-	3.70	-	V
V_{OL}	LOW-level	V _I = V _{IH} or V _{IL}								
	output voltage	$I_O = 50 \mu A; V_{CC} = 2.0 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 50 \mu A; V_{CC} = 3.0 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 50 \mu A; V_{CC} = 4.5 V$	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4 mA; V _{CC} = 3.0 V	-	-	0.36	-	0.44	-	0.55	V
		$I_O = 8 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.36	-	0.44	-	0.55	V
l _l	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	4.0	-	40	-	80	μA
Cı	input capacitance	V _I = V _{CC} or GND	-	3	10	-	10	-	10	pF

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74AHCT	594-Q100							<u>'</u>	-	'
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	-	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	-	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = -50 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		$I_O = -8.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.94	-	-	3.80	-	3.70	-	V
V _{OL}	LOW-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = 50 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 8 mA; V _{CC} = 4.5 V	-	-	0.36	-	0.44	-	0.55	V
II	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	4.0	-	40	-	80	μΑ
ΔI _{CC}	additional supply current	per input pin; $V_1 = V_{CC} - 2.1 \text{ V}$; other pins at V_{CC} or GND; $I_0 = 0 \text{ A}$; $V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	-	1.35	-	1.5	-	1.5	mA
C _I	input capacitance	V _I = V _{CC} or GND	-	3	10	-	10	-	10	pF

11. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 15.

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
74AHC5	94-Q100		•							
t _{PLH}		SHCP to Q7S; see Fig. 9								
	propagation delay	V _{CC} = 3.0 V to 3.6 V								
	dolay	C _L = 15 pF	-	5.2	8.5	2.2	9.7	2.2	10.6	ns
		C _L = 50 pF	-	7.4	11.5	3.0	13.2	3.0	14.3	ns
		V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	-	3.8	6.3	1.7	7.2	1.7	7.8	ns
		C _L = 50 pF	-	4.8	8.0	2.4	9.1	2.4	10.0	ns
		STCP to Qn; see Fig. 10								
		V _{CC} = 3.0 V to 3.6 V								
		C _L = 15 pF	-	5.1	8.3	2.3	9.5	2.3	10.6	ns
		C _L = 50 pF	-	7.3	11.9	3.3	13.6	3.3	14.7	ns
		V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	-	3.5	5.7	1.8	6.5	1.8	7.1	ns
		C _L = 50 pF	-	4.8	7.8	2.6	9.0	2.6	9.8	ns

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
t _{PHL}		SHCP to Q7S; see Fig. 9								
	propagation delay	V _{CC} = 3.0 V to 3.6 V								
	delay	C _L = 15 pF	-	5.5	8.9	2.3	10.2	2.3	11.0	ns
		C _L = 50 pF	-	7.4	12.1	3.0	13.9	3.0	15.1	ns
		V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	-	4.1	6.7	1.9	7.6	1.9	8.2	ns
		C _L = 50 pF	-	5.4	8.8	2.5	10.1	2.5	11.0	ns
		STCP to Qn; see Fig. 10								
		V _{CC} = 3.0 V to 3.6 V								
		C _L = 15 pF	-	5.5	9.1	2.4	10.4	2.4	11.3	ns
		C _L = 50 pF	-	7.3	12.0	3.2	13.8	3.2	15.0	ns
		V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	-	3.7	6.0	1.9	6.9	1.9	7.5	ns
		C _L = 50 pF	-	5.2	8.5	2.6	9.7	2.6	10.5	ns
		SHR to Q7S; see Fig. 13								
		V _{CC} = 3.0 V to 3.6 V								
		C _L = 15 pF	-	5.7	9.5	2.3	10.8	2.3	11.7	ns
		C _L = 50 pF	-	7.5	12.2	3.6	14.0	3.6	15.2	ns
		V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	-	4.1	6.7	2.0	7.6	2.0	8.2	ns
		C _L = 50 pF	-	5.4	8.8	2.8	10.1	2.8	11.0	ns
		STR to Qn; see Fig. 12								
		V _{CC} = 3.0 V to 3.6 V								
		C _L = 15 pF	-	5.8	9.6	2.8	11.0	2.8	12.0	ns
		C _L = 50 pF	-	7.7	12.5	3.8	14.4	3.8	15.6	ns
		V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	-	4.1	7.2	2.2	8.2	2.2	8.9	ns
		C _L = 50 pF	-	5.4	9.4	3.0	10.7	3.0	11.6	ns
f _{max}	maximum frequency	SHCP or STCP; see Fig. 9 and Fig. 10								
		V _{CC} = 3.0 V to 3.6 V	80	125	-	70	-	65	-	MHz
		V _{CC} = 4.5 V to 5.5 V	90	170	-	80	-	70	-	MHz
t _W	pulse width	SHCP and STCP HIGH or LOW; see Fig. 9 and Fig. 10								
		V _{CC} = 3.0 V to 3.6 V	6.0	-	-	6.5	-	7.0	-	ns
		V _{CC} = 4.5 V to 5.5 V	5.5	-	-	6.0	-	6.5	-	ns
		SHR and STR HIGH or LOW; see Fig. 13 and Fig. 12								
		V _{CC} = 3.0 V to 3.6 V	5.0	-	-	5.0	-	5.5	-	ns
		V _{CC} = 4.5 V to 5.5 V	5.0	-	-	5.2	-	5.7	-	ns

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
t _{su}	set-up time	DS to SHCP; see Fig. 11								
		V _{CC} = 3.0 V to 3.6 V	3.5	-	-	3.5	-	4.0	-	ns
		V _{CC} = 4.5 V to 5.5 V	3.0	-	-	3.0	-	3.5	-	ns
		SHR to STCP; see Fig. 14								
		V _{CC} = 3.0 V to 3.6 V	8.0	-	-	9.0	-	9.5	-	ns
		V _{CC} = 4.5 V to 5.5 V	5.0	-	-	5.0	-	5.5	-	ns
		SHCP to STCP; see Fig. 10								
		V _{CC} = 3.0 V to 3.6 V	8.0	-	-	8.5	-	9.0	-	ns
		V _{CC} = 4.5 V to 5.5 V	5.0	-	-	5.0	-	5.5	-	ns
t _h	hold time	DS to SHCP; see Fig. 11								
		V _{CC} = 3.0 V to 3.6 V	1.5	-	-	1.5	-	2.0	-	ns
		V _{CC} = 4.5 V to 5.5 V	2.0	-	-	2.0	-	2.5	-	ns
t _{rec}	recovery time	SHR to SHCP; see Fig. 13								
		V _{CC} = 3.0 V to 3.6 V	4.2	-	-	4.8	-	5.3	-	ns
		V _{CC} = 4.5 V to 5.5 V	2.9	-	-	3.3	-	3.8	-	ns
		STR to STCP; see Fig. 12								
		V _{CC} = 3.0 V to 3.6 V	4.6	-	-	5.3	-	5.8	-	ns
		V _{CC} = 4.5 V to 5.5 V	3.2	-	-	3.7	-	4.3	-	ns
C _{PD}	power dissipation capacitance	$f_i = 1 \text{ MHz}$; $V_I = \text{GND to } V_{CC}$ [2]	-	55	-	-	-	-	-	pF
74AHCT	594-Q100; V _{CC}	= 4.5 V to 5.5 V					I		1	
t _{PLH}	LOW to HIGH	SHCP to Q7S; see Fig. 9								
	propagation	C _L = 15 pF	-	3.8	6.3	1.7	7.2	1.7	7.8	ns
	delay	C _L = 50 pF	-	4.8	8.0	2.2	9.1	2.2	9.9	ns
		STCP to Qn; see Fig. 10								
		C _L = 15 pF	-	3.5	5.7	1.8	6.5	1.8	7.1	ns
		C _L = 50 pF	-	4.6	7.7	2.6	8.8	2.6	9.6	ns
t _{PHL}	HIGH to LOW	SHCP to Q7S; see Fig. 9								
	propagation	C _L = 15 pF	-	4.1	6.7	1.8	7.6	1.8	8.3	ns
	delay	C _L = 50 pF	-	5.4	8.8	2.4	10.1	2.4	11.0	ns
		STCP to Qn; see Fig. 10								
		C _L = 15 pF	-	3.7	6.1	1.9	6.9	1.9	7.2	ns
		C _I = 50 pF	-	5.2	8.5	2.6	9.7	2.6	10.5	ns
		SHR to Q7S; see Fig. 13								
		C _L = 15 pF	-	4.3	7.0	2.4	8.0	2.4	8.7	ns
		C _L = 50 pF	-	5.4	8.8	2.7	10.1	2.7	11.0	ns
		STR to Qn; see Fig. 12					, , , ,		1	
		C _L = 15 pF	_	4.5	7.4	2.3	8.4	2.3	9.2	ns
		C _L = 50 pF	_	5.7	9.4	3.1	10.7	3.1	11.7	ns
f _{max}	maximum	SHCP or STCP;	90	160	-	80	-	70	-	MHz
пах	frequency	see <u>Fig. 9</u> and <u>Fig. 10</u>								

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
t _W	pulse width	SHCP and STCP HIGH or LOW; see Fig. 9 and Fig. 10	5.5	-	-	6.0	-	6.5	-	ns
		SHR and STR HIGH or LOW; see <u>Fig. 13</u> and <u>Fig. 12</u>	5.2	-	-	5.5	-	6.0	-	ns
t _{su}	set-up time	DS to SHCP; see Fig. 11	3.0	-	-	3.0	-	3.5	-	ns
		SHR to STCP; see Fig. 14	5.0	-	-	5.0	-	5.5	-	ns
		SHCP to STCP; see Fig. 10	5.0	-	-	5.0	-	5.5	-	ns
t _h	hold time	DS to SHCP; see Fig. 11	2.0	-	-	2.0	-	2.5	-	ns
t _{rec}	recovery time	SHR to SHCP; see Fig. 13	2.9	-	-	3.3	-	3.8	-	ns
		STR to STCP; see Fig. 12	3.4	-	-	3.8	-	4.3	-	ns
C _{PD}	power dissipation capacitance	$f_i = 1 \text{ MHz}$; $V_I = \text{GND to } V_{CC}$ [2]	-	55	-	-	-	-	-	pF

- [1] Typical values are measured at nominal supply voltage (V_{CC} = 3.3 V and V_{CC} = 5.0 V). [2] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W). P_D = C_{PD} x V_{CC} 2 x f_i x N + Σ (C_L x V_{CC} 2 x f_o) where:

 f_i = input frequency in MHz;

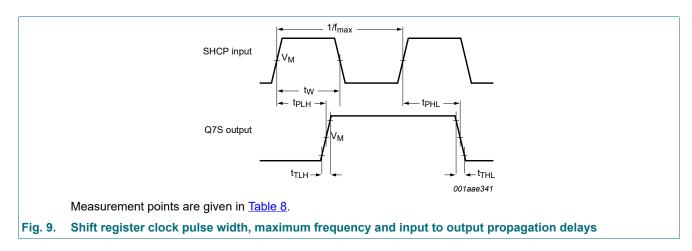
f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching; $\Sigma(C_L \ x \ V_{CC} \ ^2 \ x \ f_o) = sum \ of the \ outputs.$

11.1. Waveforms and test circuit



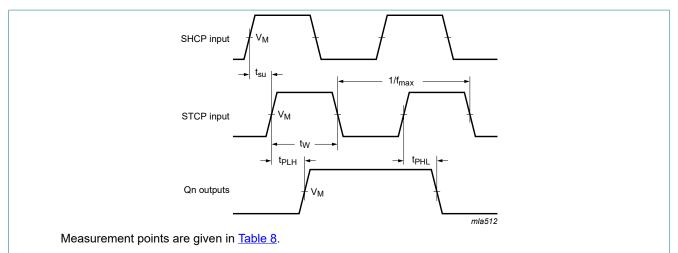


Fig. 10. Shift register clock to storage register clock set-up time and storage clock pulse width, maximum frequency and input to output propagation delays

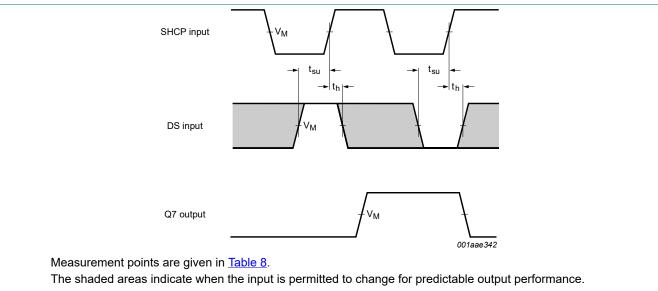
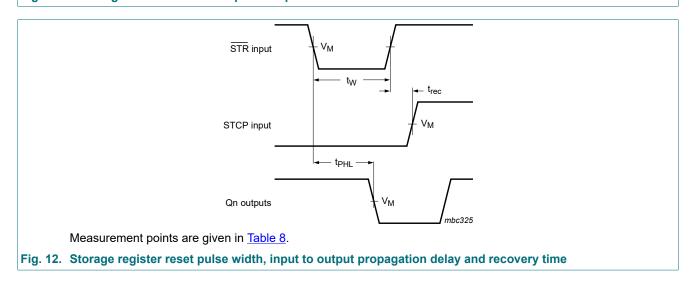
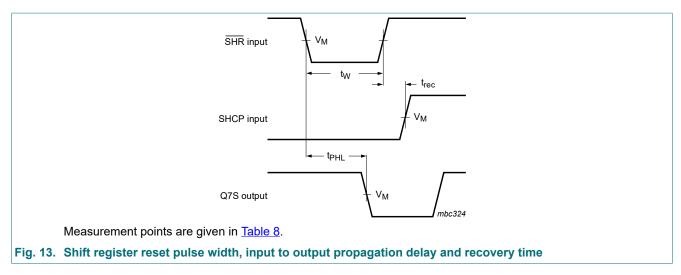


Fig. 11. Shift register clock to data input set-up and hold times



Product data sheet



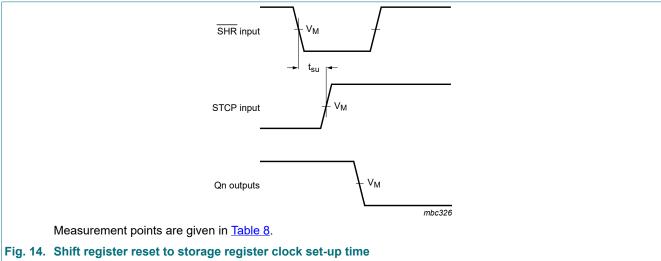
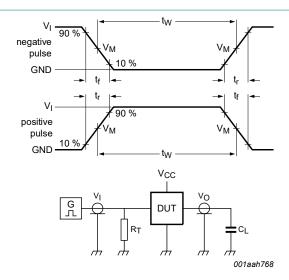


Table 8. Measurement points

Туре	Input	Output								
	V _M	V _M								
74AHC594-Q100	0.5 x V _{CC}	0.5 x V _{CC}								
74AHCT594-Q100	1.5 V	0.5 x V _{CC}								



For test data see Table 9.

Definitions for test circuit:

 R_{T} = Termination resistance should be equal to output impedance Z_{o} of the pulse generator.

 C_L = Load capacitance including jig and probe capacitance.

Fig. 15. Test circuit for measuring switching times

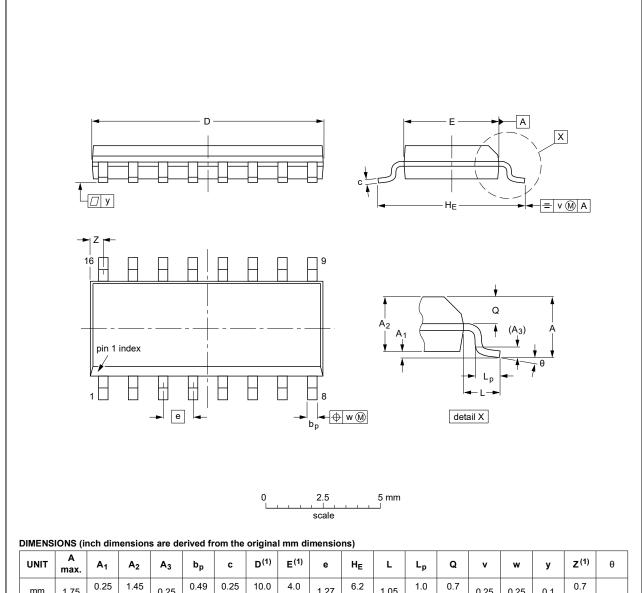
Table 9. Test data

Туре	Input		Load	Test
	VI	t _r , t _f	CL	
74AHC594-Q100	V _{CC}	≤ 3.0 ns	15 pF, 50 pF	t _{PLH} , t _{PHL}
74AHCT594-Q100	3.0 V	≤ 3.0 ns	15 pF, 50 pF	t _{PLH} , t _{PHL}

12. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

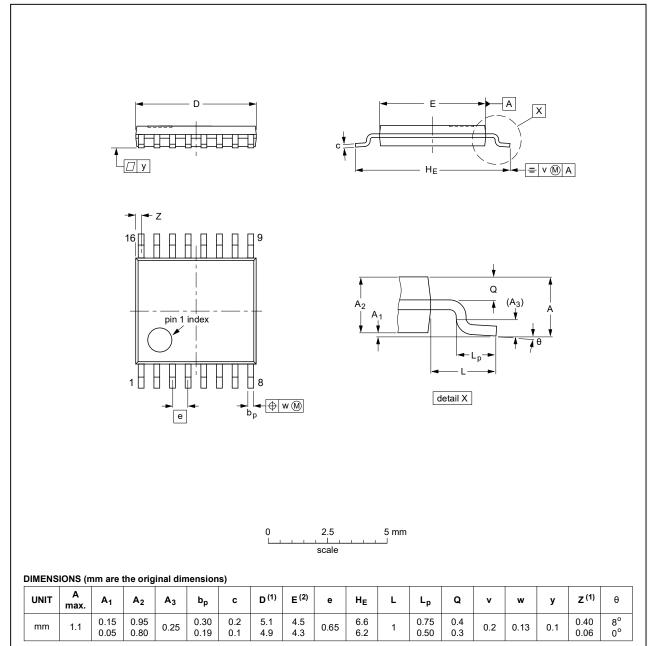
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT109-1	076E07	MS-012				99-12-27 03-02-19	

Fig. 16. Package outline SOT109-1 (SO16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT403-1		MO-153				99-12-27 03-02-18	

Fig. 17. Package outline SOT403-1 (TSSOP16)

Product data sheet

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

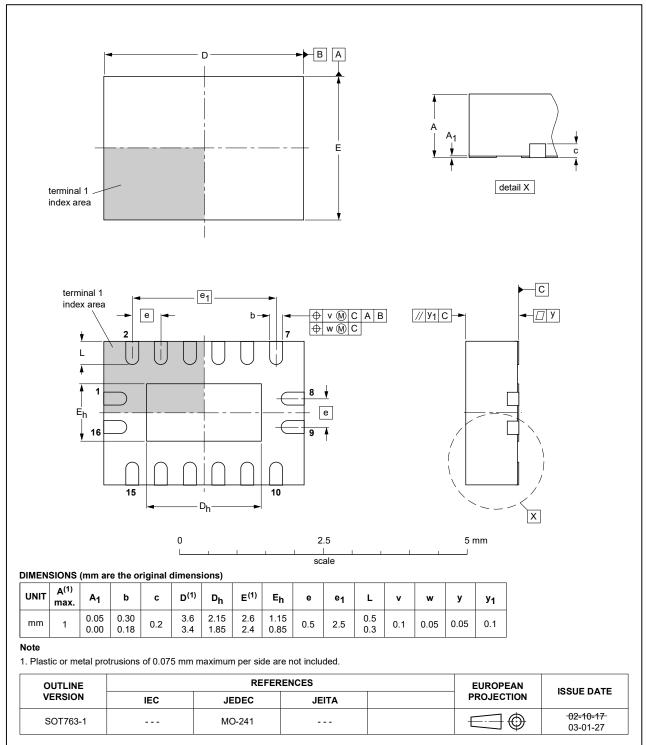


Fig. 18. Package outline SOT763-1 (DHVQFN16)

13. Abbreviations

Table 10. Abbreviations

Acronym	Description			
CMOS	Complementary Metal-Oxide Semiconductor			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
НВМ	Human Body Model			
LSTTL	Low-power Schottky Transistor-Transistor Logic			
MIL	Military			
MM	Machine Model			
TTL	Transistor-Transistor Logic			

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes				
74AHC_AHCT594_Q100 v.4	20210707	Product data sheet	-	74AHC_AHCT594_Q100 v.3				
Modifications:	Type number	Type number 74AHCT594DB-Q100 (SOT338-1/SSOP16) removed.						
74AHC_AHCT594_Q100 v.3	20200625	Product data sheet	-	74AHC_AHCT594_Q100 v.2				
Modifications:	 The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Type number 74AHC594DB-Q100 (SOT338-1/SSOP16) removed. Section 2 updated. Table 4: Derating values for P_{tot} total power dissipation updated. 							
74AHC_AHCT594_Q100 v.2	20130704	Product data sheet	-	74AHC_AHCT594_Q100 v.1				
Modifications:	 74AHC594DB-Q100 and 74AHCT594DB-Q100 added. 							
74AHC_AHCT594_Q100 v.1	20120712	Product data sheet	-	-				

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

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